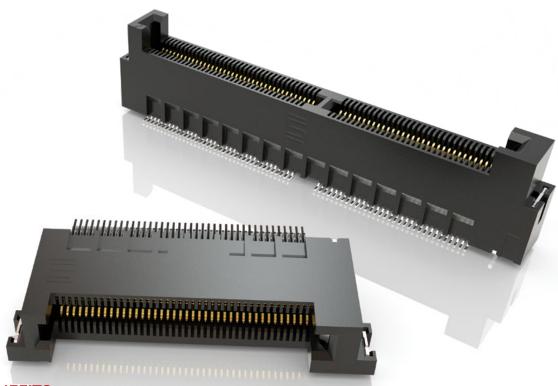
# MICRO EDGE CARD SYSTEMS

0.50 mm, 0.635 mm, 0.80 mm, 1.00 mm, 1.27 mm, 2.00 mm PITCH



### **FEATURES & BENEFITS**

- Up to 56 Gbps PAM4
- PCI Express® 4.0 (MEC5 Series)
- Solutions for .062" (1.60 mm), and .093" (2.36 mm) thick cards
- Choice of pitch: 0.50 mm, 0.635 mm, 0.80 mm, 1.00 mm, 1.27 mm, 2.00 mm
- Vertical, right-angle, edge mount
- Available in surface mount and through-hole



Staggered press-fit tails (MEC8-VP)



Justification beam ensures card and body are flushed (MEC5)

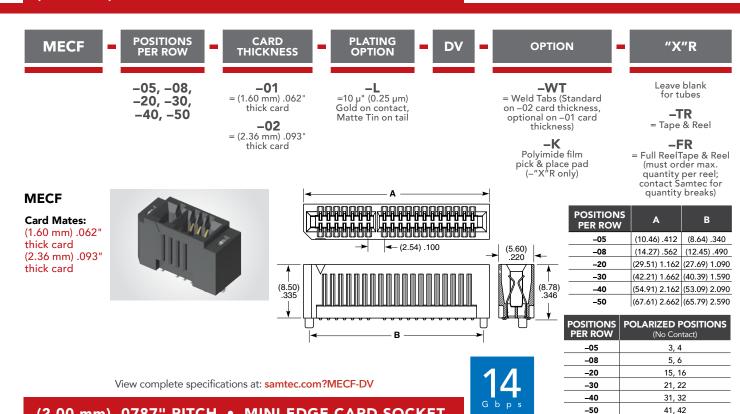
## **KEY SPECIFICATIONS**

SERIES	PITCH	TOTAL POSITIONS	INSULATOR MATERIAL	CONTACT MATERIAL	OPERATING TEMP RANGE	CURRENT RATING	VOLTAGE RATING	LEAD-FREE SOLDERABLE
MEC5	0.50 mm	60-200	Black LCP	Phosphor Bronze	-55 °C to +125 °C	1.5 A (2 pins)	125 VAC	Yes
MEC6	0.635 mm	20-140	Black LCP	Phosphor Bronze	-55 °C to +125 °C	2.4 A (2 pins)	195 VAC	Yes
MEC8	0.80 mm	20-140	Black LCP	Phosphor Bronze	-55 °C to +125 °C	1.8 A (4 pins)	185 VAC	Yes
MEC1	1.00 mm	20-140	Black LCP	Phosphor Bronze	-55 °C to +125 °C	2.2 A (2 pins)	250 VAC	Yes
MECF	1.27 mm	10-100	Black/Natural LCP	BeCu	-55 °C to +125 °C	3.5 A (2 pins)	280 VAC	Yes
MEC2	2.00 mm	10-100	Black/Natural LCP	BeCu	-55 °C to +125 °C	3.5 A (2 pins)	238 VAC	Yes

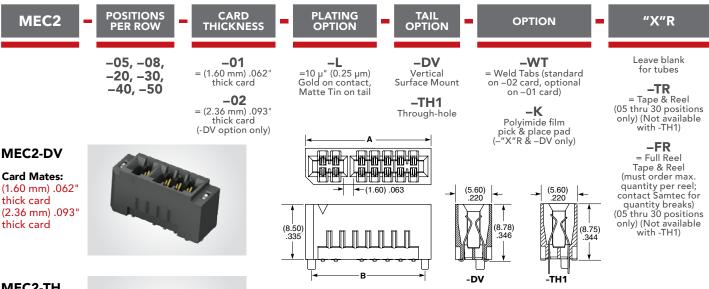




# (1.27 mm) .050" PITCH • MINI EDGE CARD SOCKET







#### MEC2-TH

**Card Mates:** (1.60 mm) .062" thick card



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**		141	

#### Note: Some sizes, styles and options are non-standard,

non-returnable.

POSITIONS Α В **PER ROW** -05 (13.40) .528 (11.50) .453 -08 (19.40) .764 (17.50) .689 -20 (43.40) 1.709 (41.50) 1.634 -30 (63.40) 2.496 (61.50) 2.421 -40 (83.40) 3.283 (81.50) 3.209 -50 (103.40) 4.071 (101.50) 3.996

POSITIONS PER ROW	POLARIZED POSITIONS (No Contact)
-05	3, 4
-08	5, 6
-20	15, 16
-30	21, 22
-40	31, 32
-50	41, 42

View complete specifications at: samtec.com?MEC2-DV & samtec.com?MEC2-TH